High Power LED Series 3535

LH351H 2W 660nm Deep Red Ver.3

For Horticulture Lighting



Features & Benefits

- Package : 2pad design with Al₂O₃
- Dimension : 3.5 mm X 3.5 mm
- Maximum current : 1.0 A
- Technology : AlGaInP



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1. Characteristics

a) Absolute Maximum Rating

| Item | Symbol | Rating | Unit | Condition |
|---|------------------|------------|---------|-----------|
| Ambient / Operating Temperature | Ta | -40 ~ +105 | ٥C | Note 1)* |
| Storage Temperature | T _{stg} | -40 ~ +105 | ٥C | - |
| LED Junction Temperature | Tj | 125 | ٥C | - |
| Forward Current (T _i : 25 °C) | l _F | 1000 | mA | Note 2)*- |
| Reverse Voltage ((@ 10 mA) | Vr | 1.1 | V | - |
| Assembly Process Temperature | | 280 <10 | °C s | - |
| ESD (HBM) | - | ±8 | kV | - |

Notes:

1) Refer to the derating curve, '3. Typical Characteristics Graph', for proper driving current that maintained below maximum junction temperature.

2) Unpredictable performance may be resulted by driving the product at above Max. IF. But there will be no damage to the product.

b) Electro-optical Characteristics

| ltem | Unit | Cond I _F (mA) | ition T _j (°C) | Value (typ.) |
|--|--------|-----------------------------|------------------------------|--------------|
| Radiant Power (Φ_E) | mW | 700 | 25 | 1035 |
| Photosynthetic Photon Flux (PPF) * | µmol/s | 700 | 25 | 5.65 |
| Forward Voltage (V _F) | V | 700 | 25 | 2.07 |
| Thermal Resistance (junction to solder point) | °C/W | 700 | 25 | 3.0 |
| Beam Angle | 0 | 700 | 25 | 130 |
| Peak wavelength (λ_p) | nm | 700 | 25 | 660 |
| Dominant wavelength (λ_D) | nm | 700 | 25 | 638 |

Notes:

1) Samsung maintains measurement tolerance of: Radiant Power = ± 7 %, forward voltage = ± 0.1 V, Wavelength = ± 2 nm

2) Characteristics @ 25 °C are for reference only

3) Calculated PPF value is for reference only

2. Product Code Information

| 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 | 16 | 17 | 18 |
|---|---|---|---|---|---|---|---|---|----|----|----|----|----|----|----|----|----|
| S | | | | | | | | | | | | | | | | | |

| Digit | Digit PKG Information | | Specification |
|-------|----------------------------|-----|---------------|
| 1 2 3 | Samsung Package High Power | SPH | |
| 4 5 | Color | RD | Red |
| 6 | Product Version | 3 | |
| 78 | Product | L3 | LH351 Series |
| 9 | Lens Type | D | Dome lens |
| 10 | Internal Code | н | |
| 11 | Wattage | 2 | 2W |
| 12 | Sorting Temperature | 0 | 25 °C |
| 13 14 | Forward Voltage (V) | C5 | 1.8 ~ 2.3V |
| 15 16 | Wavelength (nm) | W4 | 650 ~ 670 |
| 17 18 | Radiant Power (mW) | 3B | 995 ~ 1120 |

a) Voltage Bins (I_F = 700 mA, T_j = 25 °C)

| Product Code | Voltage Rank | Voltage Bin | Voltage Range (V) |
|--------------------|--------------|-------------|----------------------|
| SPHRD3L3DH20C5W43B | C5 | EA | 1.8 ~ 2.05 |
| 3FRKD3L3DR20C3W43B | 65 | EB | 2.05 ~ 2.3 |

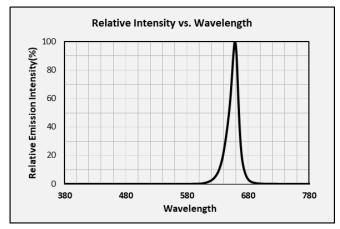
b) Wavelength Bins ($I_F = 700 \text{ mA}, T_j = 25 \text{ }^{\circ}\text{C}$)

| Product Code | Wavelength Rank | Wavelength Bin | Wavelength Range (nm) |
|--------------------|-----------------|----------------|--------------------------|
| SPHRD3L3DH20C5W43B | W4 | W4 | 650 ~ 670 |

c) Radiant Power Bins ($I_F = 700 \text{ mA}, T_j = 25 \text{ °C}$)

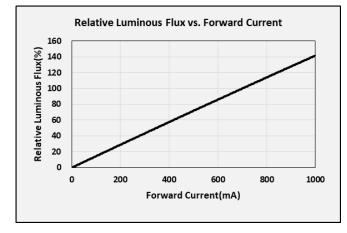
| Product Code | Power Rank | Power Bin | Power Range (mW) |
|--------------------|------------|-----------|------------------|
| | | 10 | 995 ~ 1030 |
| | 20 | 20 | 1030 ~ 1060 |
| SPHRD3L3DH20C5W43B | 3B | 30 | 1060 ~ 1090 |
| | | 40 | 1090 ~ 1120 |

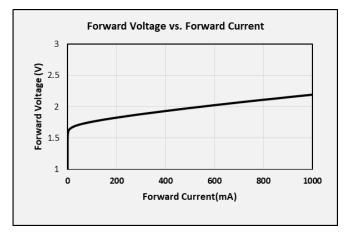
3. Typical Characteristics Graphs



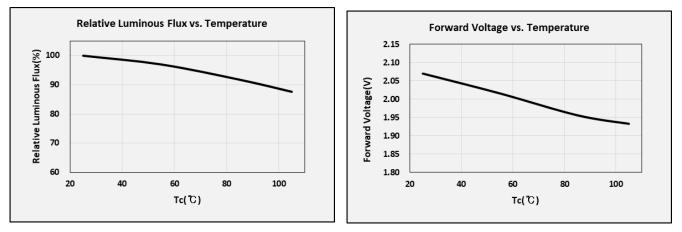
a) Spectrum Distribution ($I_F = 700 \text{ mA}, T_j = 25 \text{ °C}$)

b) Forward Current Characteristics (T_j = 25 °C)

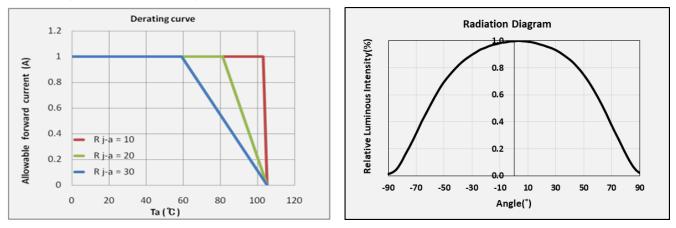




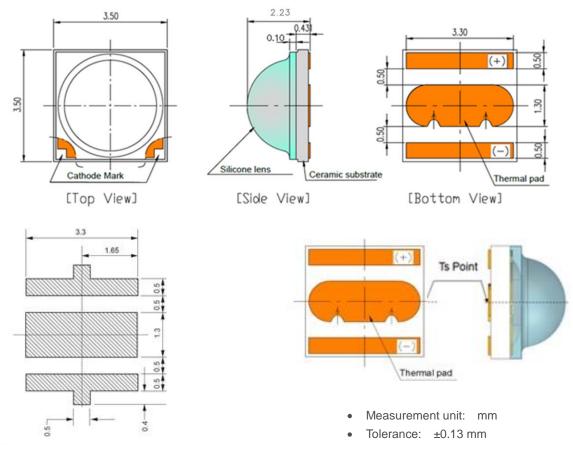
c) Temperature Characteristics ($I_F = 700 \text{ mA}$)







4. Outline Drawing & Dimension



Recommended Soldering Pattern

Notes:

- 1) This LED has built-in ESD protection device(s) connected in parallel to LED chip(s).
- 2) The thermal pad is electrically isolated from the anode and cathode contact pads.
- 3) T_s point and measurement method:
 - 1) Measure the nearest point to thermal pad as shown above. If necessary, remove PSR of PCB to reach Ts point.
 - (2) All pads must be soldered to the PCB to dissipate heat properly, otherwise the LED can be damaged.

Precautions:

- Pressure on the LEDs will influence to the reliability of the LEDs. Precautions should be taken to avoid strong pressure on the LEDs. Do not put stress on the LEDs during heating.
- 2) Re-soldering should not be done after the LEDs have been soldered. If re-soldering is unavoidable, LED's characteristics should be carefully checked before and after such repair.
- Do not stack assembled PCBs together. Since materials of LEDs is soft, abrasion between two PCB assembled with LED might cause catastrophic failure of the LEDs.

5. Reliability Test Items & Conditions

a) Test Items

| Test Item | Test Condition | Test Hour / Cycle |
|--|---|----------------------|
| High Temperature Life Test | 85 °C, Maximum Rated Drive Current | 1000 h |
| High Temperature Humidity Life Test | 85 °C, 85 % R.H., Maximum Rated Drive Current | 1000 h |
| Low Temperature Life Test | -40 °C, Maximum Rated Drive Current | 1000 h |
| Temperature Cycling | -45 °C / 15 min \leftrightarrow 125 °C / 15 min temperature change within 5 min | 500 cycles |
| High Temperature Storage | 105 °C | 1000 h |
| High Temperature Humidity Storage | 85 °C, 85 % R.H | 1000 h |
| ESD (HBM) | R_1 : 10 MΩ R_2 : 1.5 kΩ R_2 : 1.5 kΩ R_2 : 1.5 kΩ R_2 : 1.5 kΩ R_2 : 1.5 kΩ | 5 times |

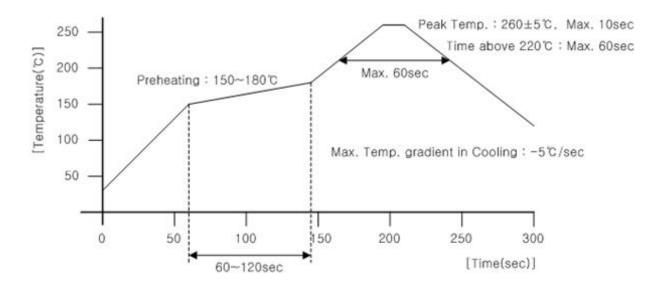
b) Criteria for Judging the Damage

| ltem | Symbol | Test Condition | Limit | | |
|-----------------|----------------|--------------------------------------|-------------------|-------------------|--|
| item | Symbol | (T _j = 25 ^o C) | Min. | Max. | |
| Forward Voltage | V _F | I _F = 700 mA | Init. Value * 0.9 | Init. Value * 1.1 | |
| Luminous Flux | Φν | I _F = 700 mA | Init. Value * 0.7 | Init. Value * 1.1 | |

6. Soldering Conditions

a) Reflow Conditions (Pb free)

Reflow frequency: 2 times max.



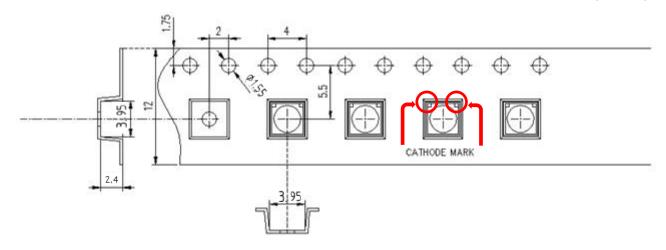
b) Manual Soldering Conditions

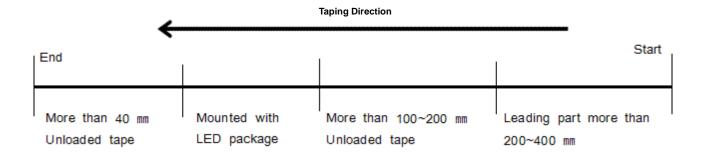
Not more than 5 seconds @ max. 300 °C, under soldering iron.

7. Tape & Reel

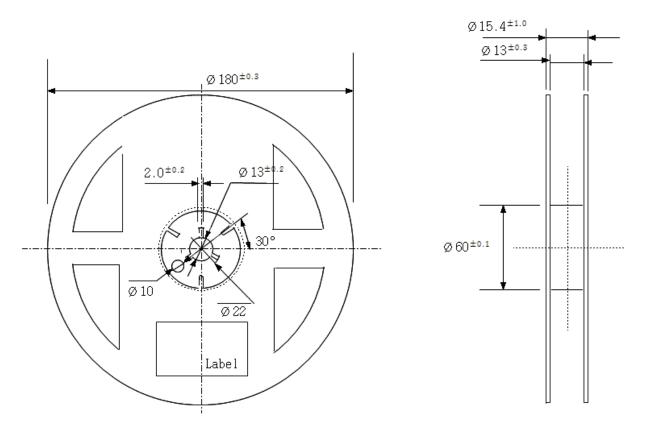
a) Taping Dimension

(unit: mm)





(unit: mm)

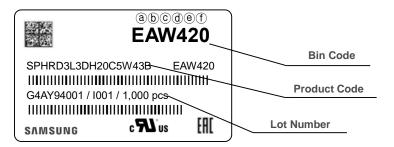


Notes:

- 1) Quantity: The quantity/reel is 1,000 pcs
- 2) Cumulative tolerance: Cumulative tolerance / 10 pitches is ±0.2 mm
- Adhesion strength of cover tape: Adhesion strength is 0.1-0.7 N when the cover tape is turned off from the carrier tape at 10° angle to the carrier tape
- 4) Packaging: P/N, Manufacturing data code no. and quantity are indicated on the aluminum packing bag

8. Label Structure

a) Label Structure



Note: Denoted bin code and product code above is only an example (see description on page 4)

Bin Code:

- (a)(b): Forward Voltage bin (refer to page 5)
- ©d: Wavelength bin (refer to page 5)
- (e) f): Radiant Power bin (refer to page 5)

b) Lot Number

The lot number is composed of the following characters:

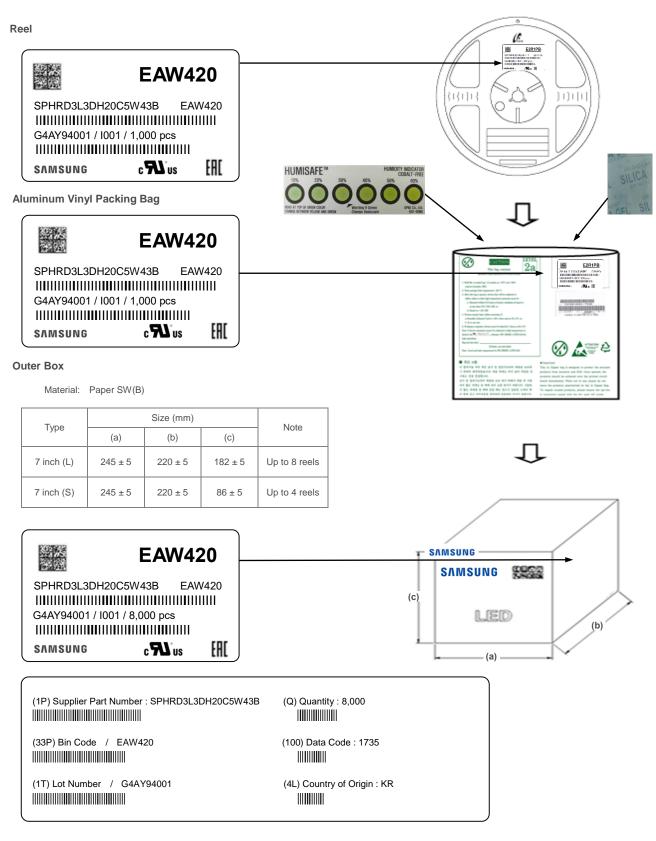
| 数次 予闭 | EAW420 | |
|---------------|-------------------|--|
| SPHRD3L3DH200 | C5W43B EAW420 | |
| 12345678 | ⊚/I@b℃/ 1,000 pcs | |
| | c 🔁 us 🛛 EAC | |

123456789/Iabc /1,000 pcs

| ③ : Product state (A: Normal, B: Bulk, C: First Production, R: Reproduction, S: Sample) ④ : Year (D: 2019, E: 2020, F:2021) ⑤ : Month (1~9, A, B, C) ⑥ : Day (1~9, A, B~V) ⑦⑧ : Product serial number (001 ~ 999) ⓐ)ⓑc : Reel number (001 ~ 999) | 1,2 | : | Production site (G4 : Guangzhou ,China) |
|---|-------|---|---|
| (5) : Month (1~9, A, B, C) (6) : Day (1~9, A, B~V) (7)(8)(9) : Product serial number (001 ~ 999) | 3 | : | Product state (A: Normal, B: Bulk, C: First Production, R: Reproduction, S: Sample) |
| 6 : Day (1~9, A, B~V) (7)⑧⑨ : Product serial number (001 ~ 999) | 4 | : | Year (D: 2019, E: 2020, F:2021) |
| (7)(8)(9) : Product serial number (001 ~ 999) | 5 | : | Month (1~9, A, B, C) |
| | 6 | : | Day (1~9, A, B~V) |
| (a)(b)(c) : Reel number (001 ~ 999) | (7)89 | : | Product serial number (001 ~ 999) |
| | abc | : | Reel number (001 ~ 999) |

9. Packing Structure

a) Packing Process

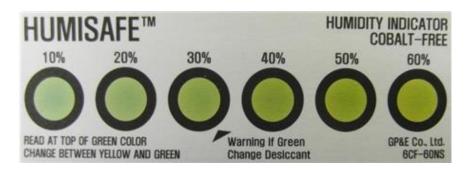




b) Silica Gel & Humidity Indicator Card inside Aluminum Vinyl Bag

(This image is for reference only. Silicagel and humidity indicator shapes may be different.)





10. Precautions in Handling & Use

- For over-current protection, users are recommended to apply resistors connected in series with the LEDs to mitigate sudden change of the forward current caused by shift of forward voltage.
- 2) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When cleaning is required, IPA is recommended as the cleaning agent. Some solvent-based cleaning agent may damage the silicone resins used in the device.
- 3) When the device is in operation, the forward current should be carefully determined considering the maximum ambient temperature and corresponding junction temperature.
- 4) LEDs must be stored in a clean environment. Shelf life of sealed bags is 12 months at temperature 0~40 °C, 0~90 % RH.
- After storage bag is opened, device subjected to soldering, solder reflow, or other high temperature processes must be:
 a. Mounted within 672 hours (28 days) at an assembly line with a condition of no more than 30 °C / 60 % RH, or
 b. Stored at <10 % RH
- 6) Repack unused devices with anti-moisture packing, fold to close any opening and then store in a dry place.
- 7) Devices require baking before mounting, if humidity card reading is >60 % at 23 ± 5 °C.
- 8) Devices must be baked for 1 hour at 60 ± 5 °C, if baking is required.
- 9) The LEDs are sensitive to the static electricity and surge current. It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs. If voltage exceeding the absolute maximum rating is applied to LEDs, it may cause damage or even destruction to LED devices. Damaged LEDs may show some unusual characteristics such as increase in leakage current, lowered turn-on voltage, or abnormal lighting of LEDs at low current.
- 10) VOCs (Volatile Organic Compounds) can be generated from adhesives, flux, hardener or organic additives used in luminaires (fixtures). Transparent LED silicone encapsulant is permeable to those chemicals and they may lead to a discoloration of encapsulant when they exposed to heat or light. This phenomenon can cause a significant loss of light emitted (output) from the luminaires. In order to prevent these problems, we recommend users to know the physical properties of materials used in luminaires and they must be carefully selected.

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